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HA31005ANP

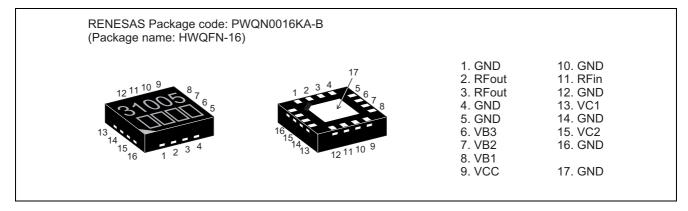
SiGe MMIC High Frequency Power Amplifier

> REJ03F0173-0200 Rev.2.00 Jul 31, 2007

Features

- Ideal for IEEE802.11a / b / g / n applications. e.g. Wireless LAN FEM
- High Gain (24 dB @ 5.2 GHz, 30dB @ 2.4 GHz)
- Small footprint package.
- (HWQFN-16 : 3.0 x 3.0 x 0.8 mm)
- RoHS Compliant

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Supply Voltage	V _{CC}	4	V
Maximum Current	I _{CC}	400	mA
Maximum Input Power	P _{in max}	+10	dBm
Total Power Dissipation	Pt	1.4 ^{note}	W
Operating Case Temperature	Tc(op)	-10 to +85	°C
Storage Temperature	Tstg	-55 to +150	°C

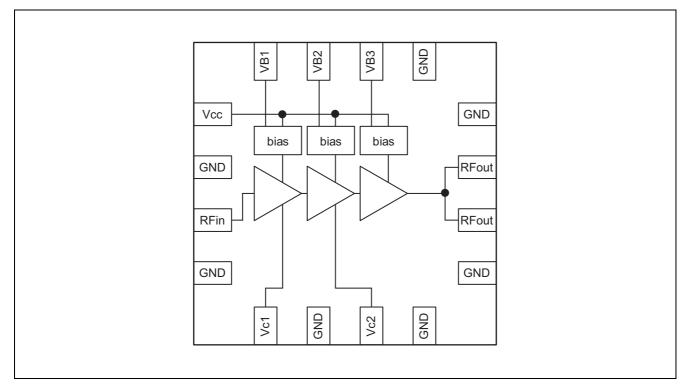
Notes: Value on PCB (FR-4 : 20 x 20 x 0.4 mm double side)

Electrical Characteristics

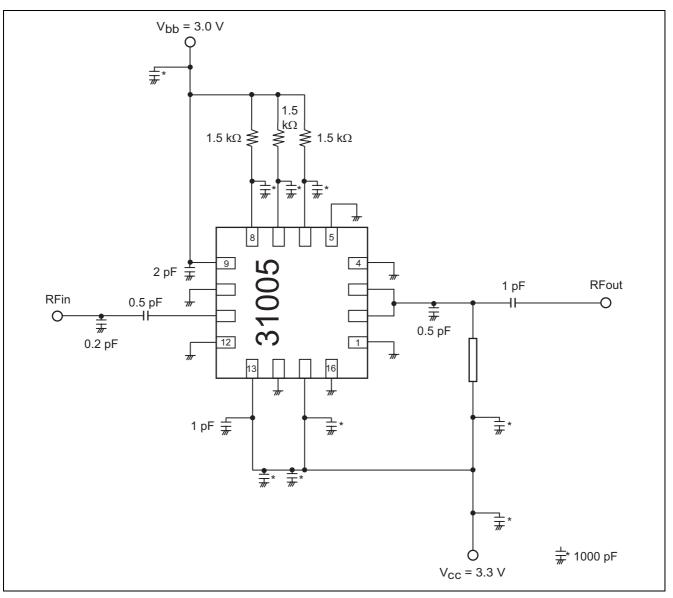
 $(Ta = 25^{\circ}C)$

Item	Symbol	Min.	Тур	Max.	Unit	Test Conditions
Supply Voltage	V _{cc}	3	3.3	3.6	V	
Power Gain	PG1		24	—	dB	f = 5.15 to 5.35 GHz
Circuit Current	lcc1		160	—	mA	Pout = +18 dBm, lcq = 130 mA
Output Power	Pout1	_	+18	—	dBm	f = 5.15 GHz , EVM = 4%, 54 Mbps, 64 QAM_OFDM, Icq = 130 mA
Power Gain	PG2		30	—	dB	f = 2.484 GHz
Circuit Current	lcc2		110	—	mA	Pout = +18 dBm, lcq = 90 mA
Output Power	Pout2	_	+18	—	dBm	f = 2.484 GHz, EVM = 4%, 54 Mbps, 64 QAM_OFDM, Icq = 90 mA
Power Gain	PG3		30	—	dB	f = 2.484 GHz, .11 b 11 Mbps
Circuit Current	Icc3	—	170	_	mA	Vcc = 3.3 V, Icq = 90 mA
Output Power	Pout3	_	+22	_	dBm	

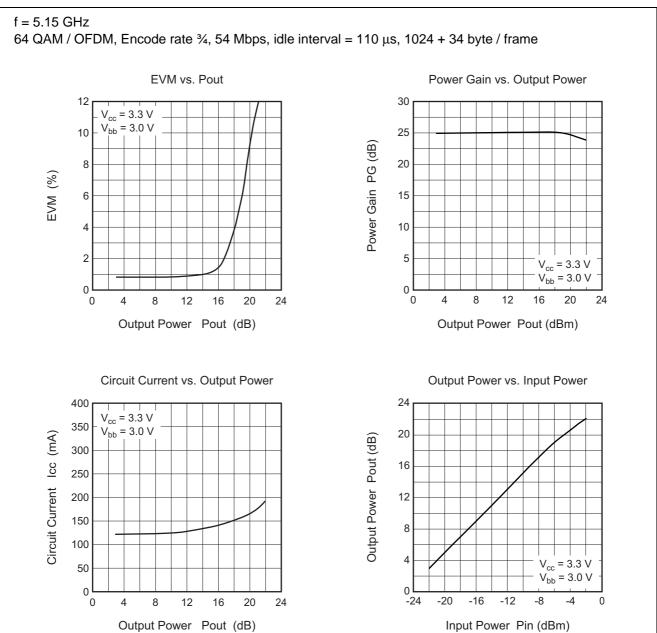
Function Block Diagram



Evaluation Circuit for IEEE 802.11a

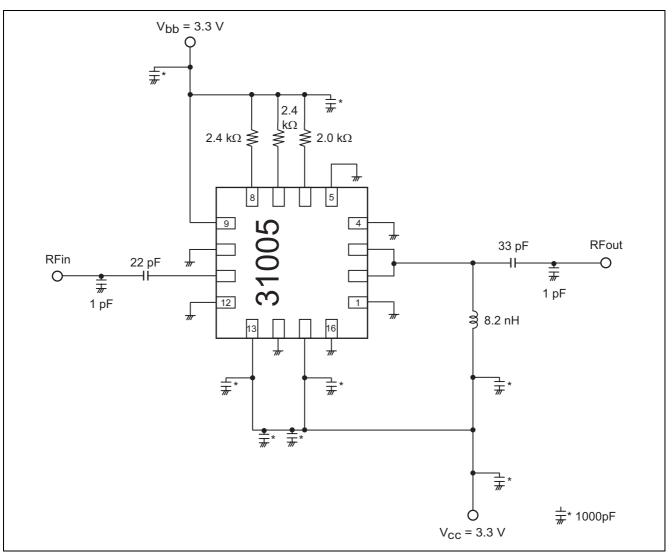


Characteristics for IEEE 802.11a



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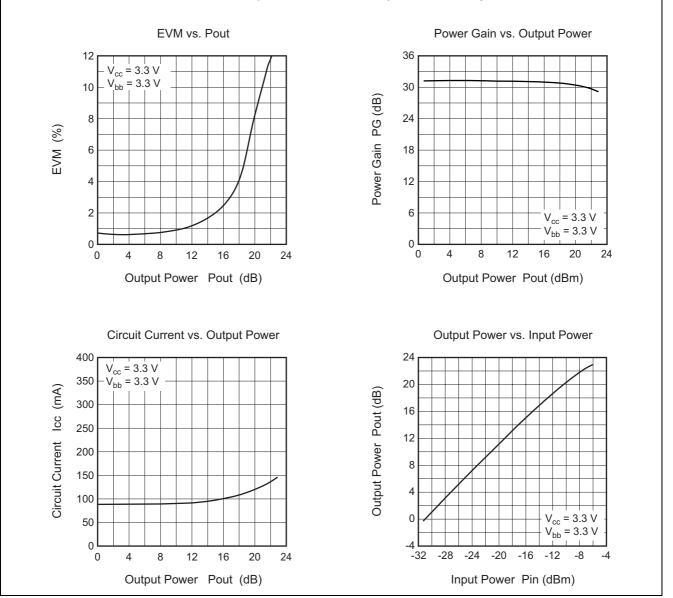
Evaluation Circuit for IEEE 802.11g



Characteristics for IEEE 802.11g

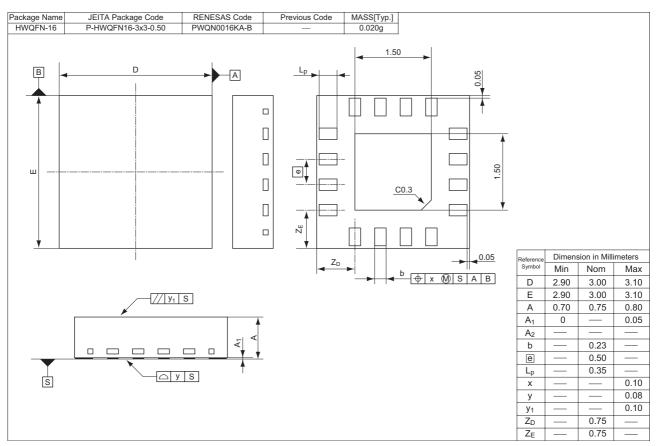


64 QAM / OFDM, Encode rate ³/₄, 54 Mbps, idle interval = 110 μs, 1024 + 34 byte / frame

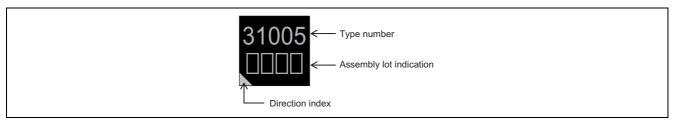


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Package Dimensions



Marking



Ordering Information

Part No.	Quantity	Shipping Container
HA31005ANPTL-E	2000 pcs.	φ178 mm reel, 12 mm emboss taping

RenesasTechnology Corp. sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

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Renesas Technology America, Inc.

450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K. Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd. Unit 204, 205, AZIACenter, No.1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120 Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7898

Renesas Technology Hong Kong Ltd. 7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2730-6071

Renesas Technology Taiwan Co., Ltd. 10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology Singapore Pte. Ltd.

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd. Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

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